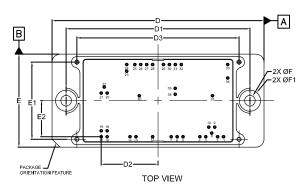
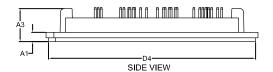
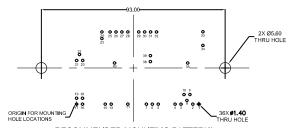


PIM40, 107.2x47 CASE 180BE **ISSUE C** 

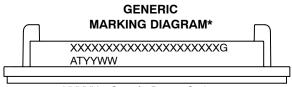
**DATE 27 JUL 2022** 







RECOMMENDED MOUNTING PATTERN\* For additional information on our Pb-Free strategy and soldering details, please download the On Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



XXXXX = Specific Device Code

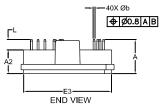
= Pb-Free Package G

= Assembly & Test Site Code YYWW = Year and Work Week Code

\*This information is generic. Please refer to device data

sheet for actual part marking. Pb-Free indicator, "G" or microdot " • ", may or may not be present. Some products may not follow the Generic Marking

	MILLIMETERS				
DIM	MIN.	NOM.	MAX.		
Α	16.63	17.23	17.83		
A1	4.50	4.70	4.90		
A2	11.60	12.00	12.40		
A3	16.40	16.70	17.00		
b	0.95	1.00	1.05		
D	106.80	107.20	107.60		
D1	92.90	93.00	93.10		
D2	28.40	28.70	29.00		
D3	81.80	82.00	82.20		
D4	104.35	104.75	105.15		
Е	46.60	47.00	47.40		
E1	38.80	39.00	39.20		
E2	17.95	18.25	18.55		
E3	44.30	44.40	44.50		
F	5.40	5.50	5.60		
F1	10.70 REF				
L	5.03	5.23	5.43		



## NOTE 4

	PIN POS	SITION	П		PIN POS	SITION
PIN	Х	Υ		PIN	Х	Υ
1	61.85	0.0		21	0.0	22.1
2	58.85	0.0		22	1.5	25.1
3	52.85	0.0		23	12.85	33.15
4	49.85	0.0		24	12.85	36.5
5	41.35	0.0		25	16.95	36.5
6	38.35	0.0		26	19.95	36.5
7	35,35	0.0		27	22,95	36.5
8	55.85	1.85	П	28	25.95	36.5
9	57.35	4.85		29	31.45	36.5
10	54.35	4.85		30	34.45	36.5
11	25.95	0.0		31	37.45	36.5
13	17.5	0.0		32	40.45	36.5
14	14.5	0.0		33	63.9	36.55
16	3.0	0.0		34	63.9	29.7
17	0.0	0.0		35	56.2	20.75
18	3.0	3.0		38	37.4	21.5
19	0.0	3.0		39	37.4	24.5
20	3.0	22.1		40	19.2	20.75

## NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME 7 14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS & APPLY TO THE PLATED TERMINALS AND ARE MEASURED WHERE THE PIN EXITS THE PACKAGE BODY.
- 4. POSITION OF THE CENTER OF THE TERMINALS IS DETERMINED FROM PIN 17. POSITIONAL TOLERANCE, AS NOTED IN THE DRAWING, APPLIES TO EACH TERMINAL.

DESCRIPTION	PIM40, 107,2x47	' '	PAGE 1 OF 1		
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